

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2772979

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUN HO CHI	03/14/2014
O SUNG KWON	03/14/2014
JONG CHAN HUR	03/14/2014
HYUCK MAN KWON	03/14/2014
BOK NAM JANG	03/14/2014
RECEIVING PARTY DATA	
Name:	CHEIL INDUSTRIES INC.
Street Address:	58 GUMI-DAERO
Internal Address:	GUMI-SI, GYEONGSANGBUK-DO
City:	GUMI-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	730-710
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14345459
CORRESPONDENCE DATA	
Fax Number:	(704)945-6735
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	704-945-6700
Email:	docket@ahpapatent.com
Correspondent Name:	MELISSA B. PENDLETON
Address Line 1:	11610 N. COMMUNITY HOUSE ROAD
Address Line 2:	SUITE 200
Address Line 4:	CHARLOTTE, NORTH CAROLINA 28277
ATTORNEY DOCKET NUMBER:	1224.123
NAME OF SUBMITTER:	MELISSA B. PENDLETON
SIGNATURE:	/Melissa B. Pendleton/
DATE SIGNED:	03/18/2014
Total Attachments: 4	

PATENT

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**RECORDATION FORM COVER SHEET
PATENTS ONLY**

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

JUN HO CHI
O SUNG KWON
JONG CHAN HUR
HYUCK MAN KWON
BOK NAM JANG

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Cheil Industries Inc.

Internal Address: _____

Street Address: 290 Gongdan-dong

City: Gumi-si

State: Gyeongsangbuk-do

Country: South Korea Zip: 730-710

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) March 14, 2014

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other _____

4. Application or patent number(s):

☐ This document is being filed together with a new application.

A. Patent Application No.(s)

14/345,459

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Additon, Higgins, Pendleton & Ashe, P.A.

Internal Address: _____

Street Address: 11610 N. Community House
Road, Suite 200

City: Charlotte

State: NC Zip: 28277-2199

Phone Number: 704-945-6700

Fax Number: 704-945-6735

Email Address: _____

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ _____

- ☒ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number _____

Authorized User Name _____

9. Signature: /Melissa B. Pendleton/

March 18, 2014

Signature

Date

Melissa B. Pendleton

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 4

ASSIGNMENT

WHEREAS, I, **Jun Ho CHI**, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; **O Sung KWON**, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; **Jong Chan HUR**, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; **Hyuck Man KWON**, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea; and **Bok Nam JANG**, a Korean citizen, with a mailing address of Cheil Industries Inc., 56 Gosan-ro, Uiwang-si, Gyeonggi-do, Republic of Korea (hereinafter referred to as "ASSIGNOR"), am a joint inventor of certain new and useful improvements (hereinafter collectively referred to as "INVENTION") in *Polycarbonate and Method of Preparing the Same*, for which an application for United States Letters Patent is being filed concurrently herewith and which application claims priority from an International Application filed on December 13, 2011, under Serial No. PCT/KR2011/009596 and a Korean application filed on September 21, 2011, under Serial No. 10-2011-0095429, all applications listed above being hereinafter referred to as the "APPLICATION"; and

WHEREAS, Cheil Industries Inc., a Korean corporation (hereinafter referred to as "ASSIGNEE"), having a principal place of business at 58 Gumi-daero, Gumi-si, Gyeongsangbuk-do 730-710, Republic of Korea, has acquired the equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in and to any and all Letters Patent that shall

be granted with respect to said INVENTION in the United States of America and all foreign countries;

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors and assigns, my equitable right, title, and interest—and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interest in and to said INVENTION and APPLICATION, in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be granted, together with the right to claim the priority of said APPLICATION in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if an assignment and sale had not been made.

I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to said ASSIGNEE or its representatives any facts known to me relating to said INVENTION, to testify in any interference or legal

proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

As the below named inventor, I hereby declare:

The application for United States Letters Patent being filed concurrently herewith was made or authorized to be made by me.

I believe that I am the original or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in the declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

<u>3. 14</u> , 2014	<u>지 준 호</u> Jun Ho CHIL
<u>3. 14</u> , 2014	<u>오 승 근</u> O Sung KWON
<u>3. 14</u> , 2014	<u>허 정 찬</u> Jong Chan HUR
<u>3. 14</u> , 2014	<u>권 혁 만</u> Hyuck Man KWON
<u>3. 14</u> , 2014	<u>장 복 남</u> Bok Nam JANG